# Specification of Thermoelectric Module TES1-03138

# **Description**

The 31 couples, 6mm  $\times$  30mm size module is a single stage module which is made of our high performance ingot to achieve superior cooling performance and 70  $^{\circ}$ C or larger delta Tmax, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

## **Features**

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

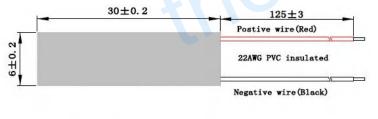
# **Application**

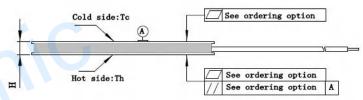
- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

# **Performance Specification Sheet**

Th (°C)	27	50	Hot side temperature at environment: dry air, N <sub>2</sub>	
DT <sub>max</sub> (°C)	70	79 Temperature Difference between cold and hot side of module when cooling capacity is zero at cold side		
U <sub>max</sub> (Voltage)	3.9	4.2	Voltage applied to the module at DT <sub>max</sub>	
I <sub>max</sub> (Amps)	4.2	4.2	DC current through the modules at DT <sub>max</sub>	
Q <sub>Cmax</sub> (Watts)	10.4	11.2	Cooling capacity at cold side of the module under DT=0 °C	
AC resistance (Ohms)	0.71	0.77	The module resistance is tested under AC	
Tolerance (%)	± 10		For thermal and electricity parameters	

#### Geometric Characteristics Dimensions in millimeters





# **Manufacturing Options**

#### A. Solder:

#### **B. Sealant:**

1. T100: BiSn (Tmelt=138°C)

1. NS: No sealing (Standard)

2. T200: CuAgSn (Tmelt =  $217^{\circ}$ C)

2. SS: Silicone sealant

3. T240: SbSn (Tmelt =  $240^{\circ}$ C)

3. EPS: Epoxy sealant

#### C. Ceramics:

#### D. Ceramics Surface Options:

1. Alumina (Al<sub>2</sub>O<sub>3</sub>, white 96%)

1. Blank ceramics (not metalized)

2. Aluminum Nitride (AlN)

2. Metalized

# **Ordering Option**

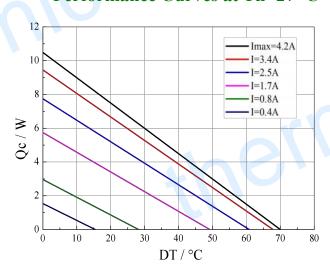
Suffix	Thickness H (mm)	Flatness/ Parallelism (mm)Parallelism (mm)	Lead wire length(mm)Standard/ Optional length
TF	$0: 3.30 \pm 0.10$	0: 0.07/0.07	125±3/Specify
TF	1: 3.30 ± 0.03	1: 0.025/0.025	125±3/Specify

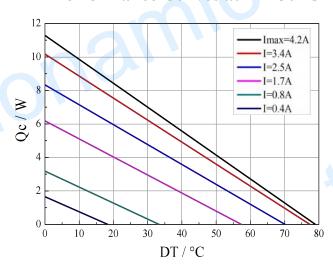
# **Specification of Thermoelectric Module**

# **TES1-03138**

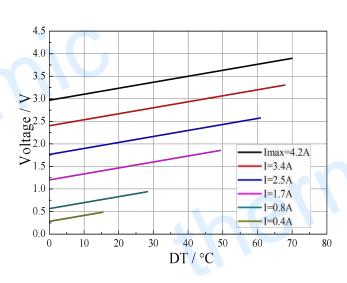
# Performance Curves at Th=27 °C

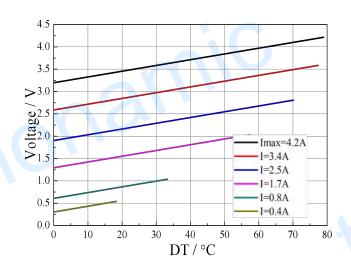
# Performance Curves at Th=50 °C



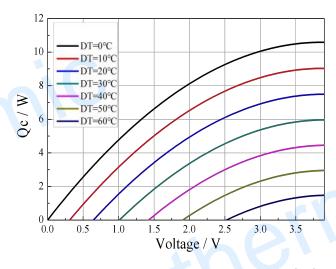


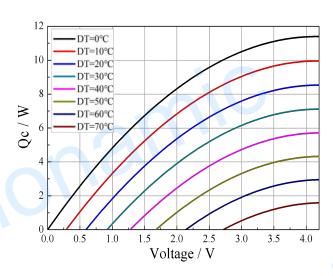
Standard Performance Graph Qc= f(DT)





Standard Performance Graph V = f(DT)





Standard Performance Graph Qc = f(V)

0.0

0.5

1.0

# **Specification of Thermoelectric Module**

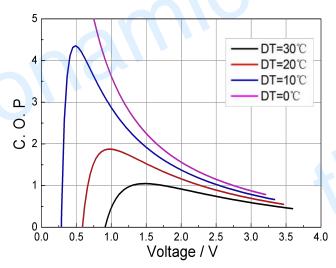
# **TES1-03138**



# DT=30°C DT=20°C DT=10°C DT=0°C

1.5 2.0 2.5 Voltage / V

## Performance Curves at Th=50 °C

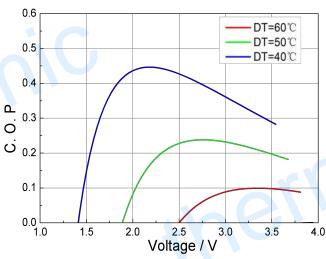


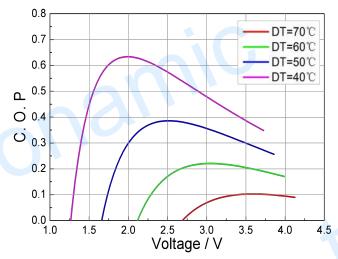
Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 °C

4.0

3.5

3.0





Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

**Remark:** The coefficient of performance (COP) is the cooling power Qc/Input power ( $V \times I$ ).

# **Operation Caution**

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I<sub>max</sub> or V<sub>max</sub>
- Work under DC

Note: All specifications subject to change without notice.